Low Noise CMOS Camera Supply - PMP9758

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer
C1, C2, C3,	15	10uF	CAP, CERM, 10uF, 25V, +/-20%, X5R, 0603	0603	GRM188R61E106MA73	MuRata
C4, C6, C7,						
C8, C9,						
C10, C11,						
C12, C13,						
C14, C15,						
C16						
L1, L2, L3	3	10uH	Inductor, Shielded, Composite, 10uH, 0.37A, 1.27 ohm,	1.9x0.6x2mm	XFL2006-103MEB	Coilcraft
			SMD			
R1	1	768k	RES, 768 k, 1%, 0.063 W, 0402	0402	CRCW0402768KFKED	Vishay-Dale
R2, R5, R8	3	243k	RES, 243 k, 1%, 0.063 W, 0402	0402	CRCW0402243KFKED	Vishay-Dale
R3, R6, R9	3	100k	RES, 100k ohm, 1%, 0.1W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
R4	1	301k	RES, 301k ohm, 1%, 0.063W, 0402	0402	CRCW0402301KFKED	Vishay-Dale
R7	1	215k	RES, 215 k, 1%, 0.063 W, 0402	0402	CRCW0402215KFKED	Vishay-Dale
U1, U2, U3	3		Buck Step Down Regulator with 3 to 17 V Input and 3.3	DSG0008A	TPS62170DSGT	Texas Instruments
			V Output, -40 to 85 degC, 8-Pin WSON (DSG), Green			
			(RoHS & no Sb/Br)			

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